# **AN7177**

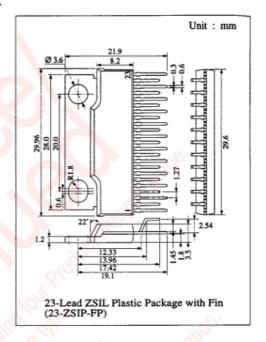
## Dual BTL 20W Audio Power Amplifier

### Description

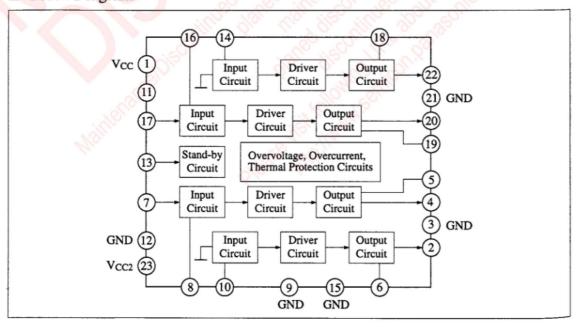
The AN7177 is a monolithic integrated circuit designed for Dual BTL audio power amplifier suitable for Hi-Fi and car stereo.

#### Features

- High output power (20W x 2)
- Incorporating stand-by circuits
- Low shock noise from power ON/OFF switching
- Fewer external components
- Incorporates protection circuits
- Highly stable operation



### ■ Block Diagram



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## ■ Absolute Maximum Ratings (Ta=25°C)

Item	Symbol	Rating	Unit
Supply Voltage	V <sub>cc</sub> *1	24	V
Supply Current	Icc	6	A
Supply Voltage Surge	V <sub>CC(surge)</sub> *2	50	V
Power Dissipation	P <sub>D</sub> *3	62.5	W
Operating Ambient Temperature	Topr	-30 ~ +75	°C
Storage Temperature	Tstg	-55 ~ +150	°C

<sup>\*1</sup> Non-signal

Operating voltage range:  $V_{CC} = 8V \sim 18V$ 

# ■ Electrical Characteristics (V<sub>CC</sub>=13.2V, R<sub>L</sub>=4Ω, f=1kHz, Ta=25°C)

Item	Item Symbol Test Circuit Condition		min.	typ.	max.	Unit	
Quiescent Current	Icq	1	$V_{in} = 0mV$		110	200	mA
Output Noise Voltage	V <sub>no1</sub> *	1	$V_{in} = 0 \text{mV}, R_g = 10 \text{k}\Omega$	300	0.6	1.5	mV
Voltage Gain	Gv	1	$V_{in} = 5mV$	49.5	51.5	53.5	dB
Total Harmonic Distortion	THD <sub>1</sub>	1	$V_{in} = 5mV$		0.15	0.75	%
Maximum Output Power	Po	1	THD = 10%	14	18		W
Ripple Rejection	RR <sub>1</sub> *	1	$R_g = 0\Omega, V_{in} = 0mV, V_r = 300mV,$ $f_r = 120Hz$	45	55	200	dB
Output Offset Voltage	V <sub>O(offset)</sub>	1	$V_{in} = 0mV$	-300	0	+300	mV
Channel Balance	СВ	1	V <sub>in</sub> = 5mV	-1	0	+1	dB
Output Noise Voltage	V <sub>no2</sub> *	2	$V_{in} = 0 \text{mV}, R_g = 10 \text{k}\Omega, G_V = 41 \text{dB}$	160	0.21	-0.72	mV
Total Harmonic Distortion	THD <sub>2</sub>	2	$V_{in} = 10 \text{mV}, G_V = 41 \text{dB}$ 0.05			%	
Ripple Rejection	RR <sub>2</sub> *	2	$R_g = 0\Omega$ , $V_{in} = 0$ mV, $V_r = 300$ mV, $f_r = 120$ Hz, $G_V = 41$ dB	1 04 1			dB

<sup>\*</sup> With 15Hz ~ 30kHz (12dB/OCT) filter

### Pin

Pin No	Pin Name	Pin No	Pin Name
1	Vcc	13	Stand-by
2	Output Ch.1	14.	N.F.B. Ch.2
3	GND (Output Ch.1)	15	GND (Input Ch.2)
4	Output Ch.1	16	N.F.B. Ch.2
5	Bootstrap Ch.1	17	Input Ch.2
6	Bootstrap Ch.1	18	Bootstrap Ch.2
7	Input Ch.1	19	Bootstrap Ch.2
8	N.F.B. Ch.1	20	Output Ch.2
9	GND (Input Ch.1)	21	GND (Output Ch.2)
10	N.F.B. Ch.1	22	Output Ch.2
11	Ripple Filter	23	V <sub>CC2</sub>
12	GND (Input)		

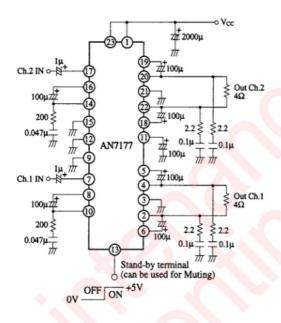
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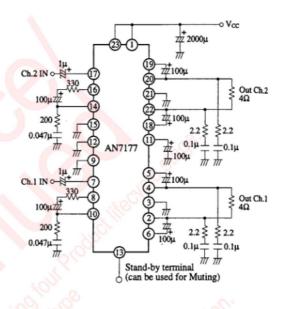
<sup>\*2</sup> Time = 0.2s

<sup>\*3</sup>  $R\theta_{j-c} = 2^{\circ}C/W$ 

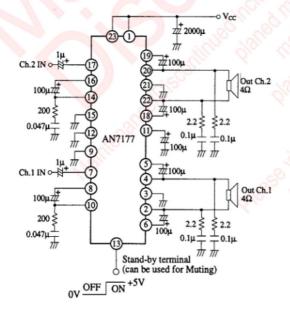
Test Circuit 1 (Icq, Vno1, Gv, THD<sub>1</sub>, Po, RR<sub>1</sub>, Vo(offset), CB)

Test Circuit 2 (V<sub>no2</sub>, THD<sub>2</sub>, RR<sub>2</sub>)



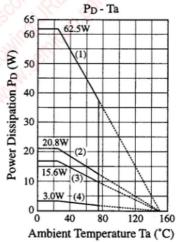


### **Application Circuit**



#### Characteristics Curve

- Tc=Ta (θ<sub>j-c</sub>=2°C/W)
  With a 100cm<sup>2</sup> x 3mm Al heat sink (black colour coated) or a 200cm<sup>2</sup> x 2mm Al heat sink (not lacquered)
- With a 100cm2 x 2mm Al heat sink (not lacquered)
- (4) Without heat sink



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